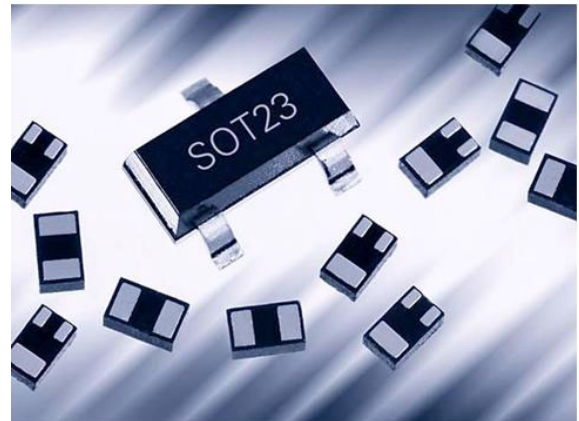
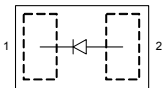


**Silicon Schottky Diode**

- RF Schottky diode for mixer applications up to 26 GHz
- Extremely low inductance combined with ultra low device capacitance
- Very stable performance for all major parameters
- Package size: 0.62 x 0.31 x 0.31 mm<sup>3</sup> only
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101


**BAT24-02LS**


Type	Package	Configuration	$L_S$ (nH)	Marking
BAT24-02LS	TSSLP-2-1	single, leadless	0.2 ±0.05	S

**Maximum Ratings at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Value	Unit
Diode reverse voltage	$V_R$	4	V
Forward current	$I_F$	110	mA
Total power dissipation $T_S \leq 73^\circ\text{C}$	$P_{\text{tot}}$	100	mW
Junction temperature	$T_j$	150	°C
Operating temperature range	$T_{\text{op}}$	-55 ... 150	
Storage temperature	$T_{\text{stg}}$	-55 ... 150	

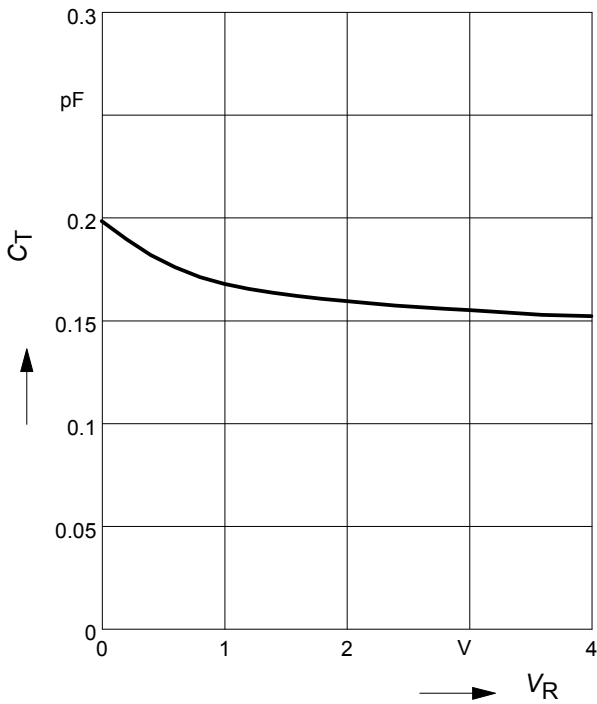
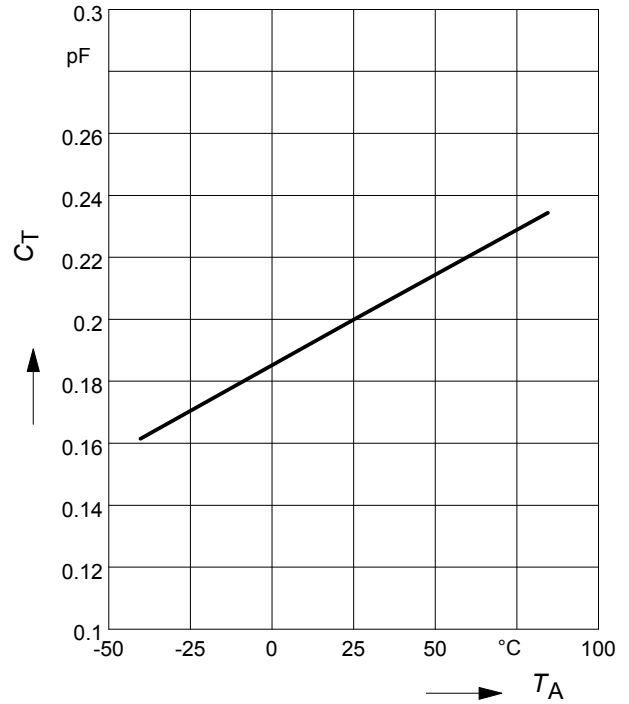
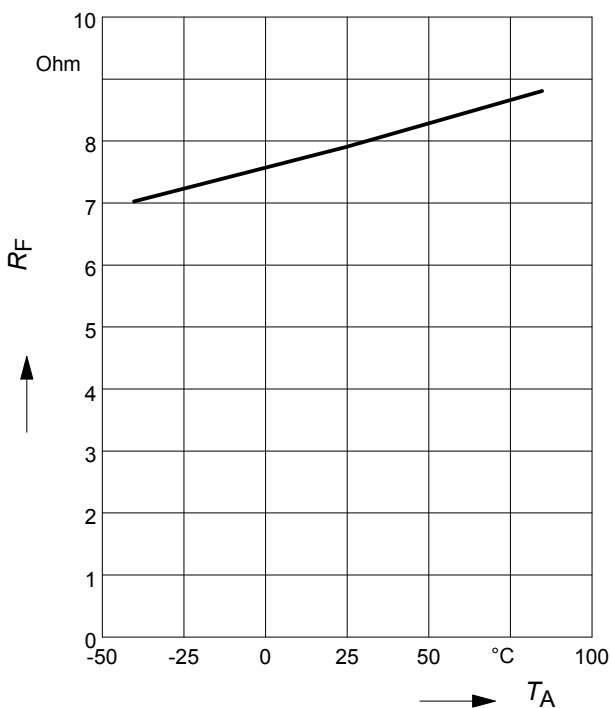
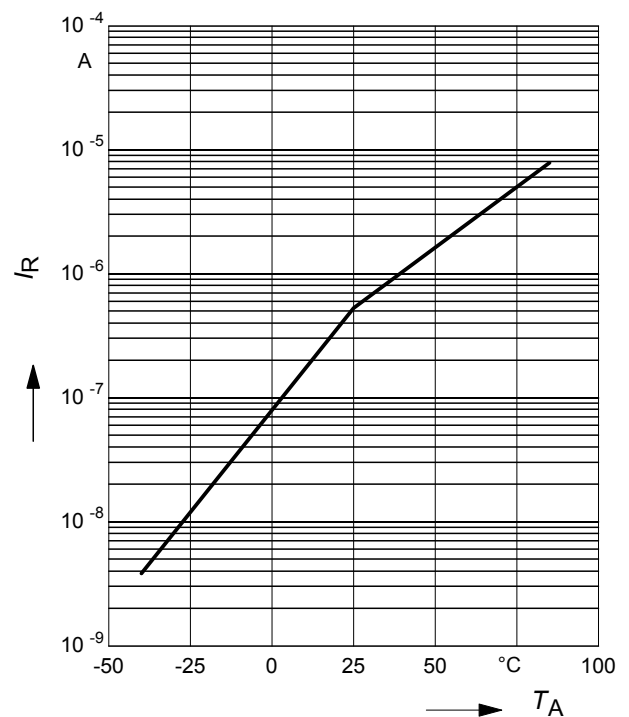
**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{\text{thJS}}$	≤ 770	K/W

<sup>1)</sup>For calculation of  $R_{\text{thJA}}$  please refer to Application Note Thermal Resistance

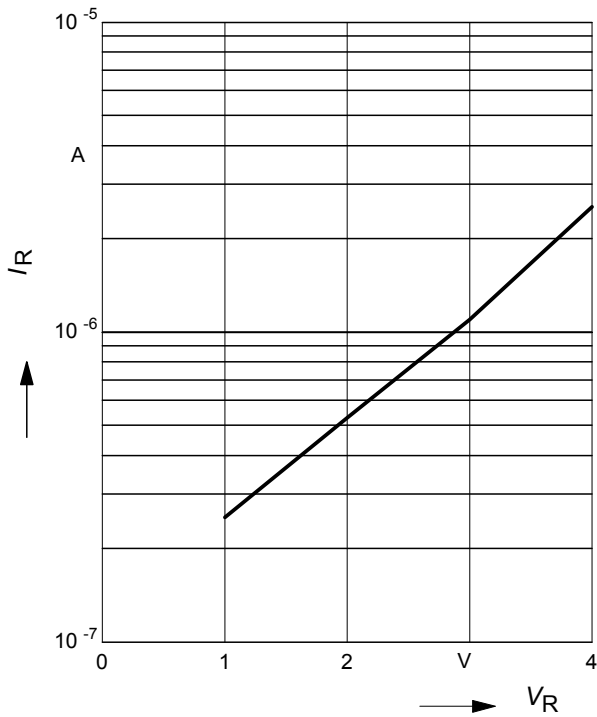
**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>DC Characteristics</b>					
Breakdown voltage $I_{(BR)} = 10 \mu\text{A}$	$V_{(BR)}$	4	-	-	V
Reverse current $V_R = 1 \text{ V}$	$I_R$	-	-	5	$\mu\text{A}$
Forward voltage $I_F = 1 \text{ mA}$ $I_F = 10 \text{ mA}$	$V_F$	0.16 0.25	0.23 0.32	0.32 0.41	V
<b>AC Characteristics</b>					
Diode capacitance $V_R = 0 \text{ V}, f = 1 \text{ MHz}$	$C_T$	-	0.2	0.23	pF
Differential forward resistance $I_F = 10 \text{ mA} / 50 \text{ mA}$	$R_F$	-	8	10	$\Omega$

**Diode capacitance  $C_T = f(V_R)$** 
 $f = 1\text{MHz}, T_A = 25\text{ }^\circ\text{C}$ 

**Diode capacitance  $C_T = f(T_A)$** 
 $V_R = 0\text{ V}, f = 1\text{MHz}$ 

**Differential forward resistance  $R_F = f(T_A)$** 
 $I_F = 10\text{ mA} / 50\text{ mA}$ 

**Reverse current  $I_R = f(T_A)$** 
 $V_R = 1\text{ V}$ 


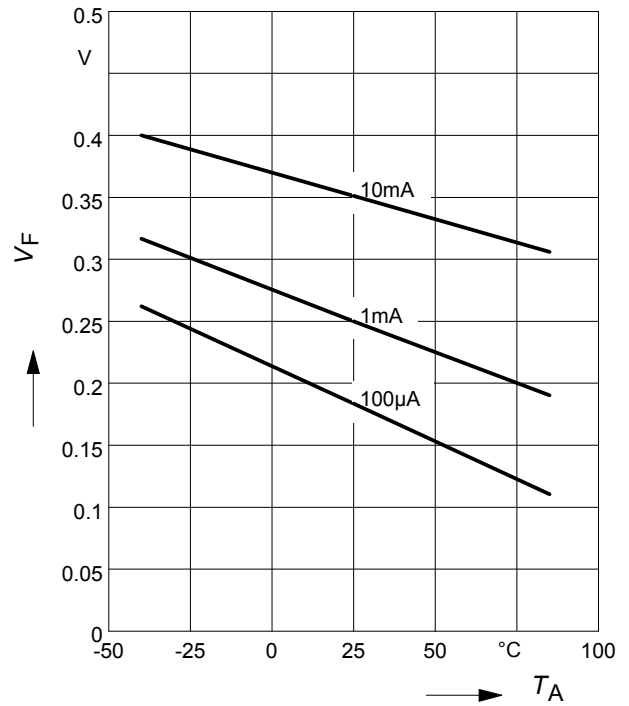
Reverse current  $I_R = f(V_R)$

$T_A = 25\text{ }^\circ\text{C}$



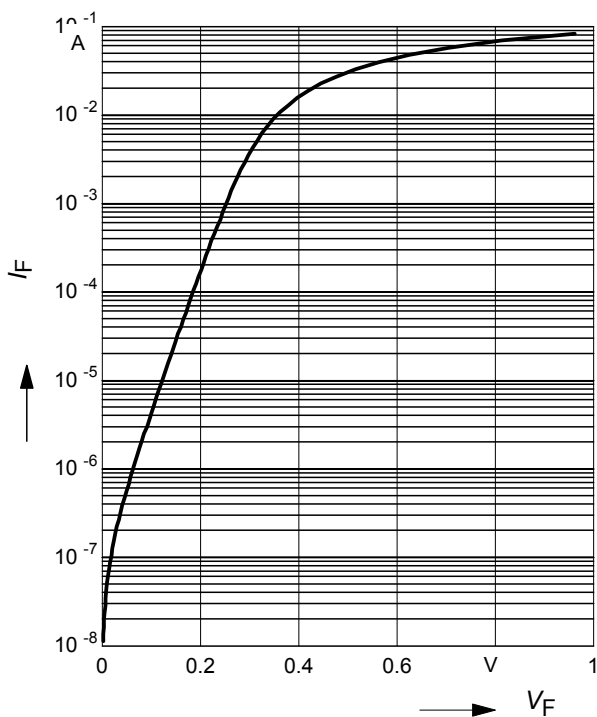
Forward Voltage  $V_F = f(T_A)$

$I_F = \text{Parameter}$

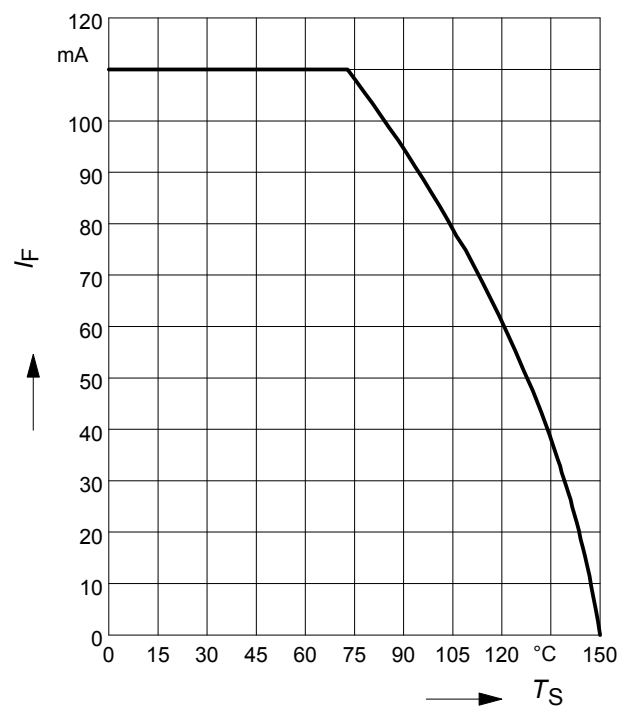


Forward current  $I_F = f(V_F)$

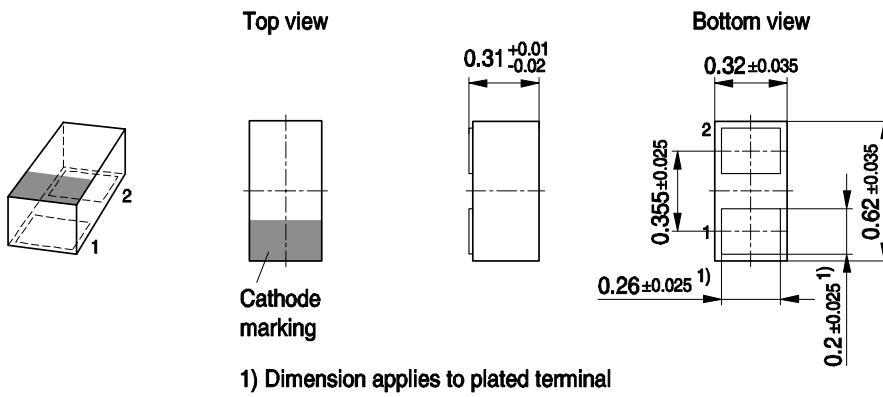
$T_A = 25\text{ }^\circ\text{C}$



Forward current  $I_F = f(T_S)$

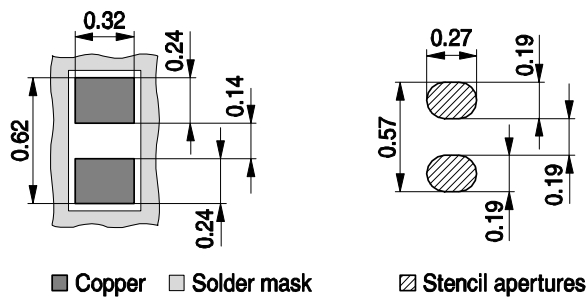


### Package Outline

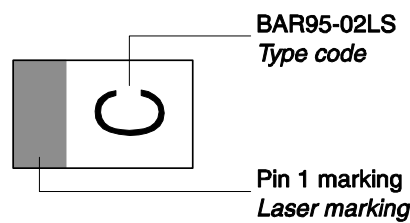


### Foot Print

For board assembly information please refer to Infineon website "Packages"

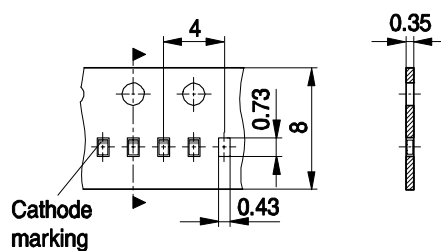


### Marking Layout (Example)



### Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel



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